





10th International Conference On Embedded Systems

Sponsored By

VLSI Society Of India (VSI)
Ministry Of Communications & Information
Technology, Govt. Of India (MCIT)
India Semiconductor Association (ISA)

In Association With

IEEE Circuits and Systems Society
IEEE ED/SSC/CAS Bangalore Chapter
ACM SIGDA

INVITATION TO SPONSORS

Dear Industry Leader,

VLSI2011, the 24th International Conference on VLSI Design and the 10th International Conference on Embedded Systems, will be jointly held at the Indian Institute of Madras, Chennai, Tamil Nadu, India, between January 2nd – 7th, 2011, with the theme "*Embedded Solutions for Emerging Markets*".

The conference will provide a vibrant platform for a wide cross section of academic and working professionals to interact and exchange useful ideas. We are expecting participation by business leaders, academic scholars and engineers from all over the world. Typically over a thousand delegates participate in the conferences making it *the largest of its kind* – and the oldest flagship event in India. Here the 3 pillars of the domain -- *Academia, Research and Industry* -- come together with the common purpose of demonstrating their latest achievements, debating the state-of-the-art, and exploring possibilities & collaborations. The joint conference will act as a unique catalyst to accelerate the involvement of Indian companies in the VLSI design and embedded systems space.

At VLSI 2011, there will be several high caliber technical papers, topical tutorials, visionary keynotes and insightful panel discussions centered around the theme of the conference "*Embedded Solutions for Emerging Markets*". The conferences will also show-case indigenous efforts from India through the acclaimed '*Made For India*' framework at the informative Industry Forum. Also on display will be efforts from students, which have been carefully hand-picked by an eminent jury.

Please find below details of the sponsorship opportunities. I request your <u>early decision</u> to participate which will be invaluable for us in planning and ensuring that the conference will exceed your expectations. We will be glad to provide more details and work closely with you as needed, to ensure maximum returns to you as a sponsor.

The enclosed brochure provides details to enable you to plan for participation. We look forward to working with you to make VLSI Design Conference 2011 a huge success.

Best Regards,

Vasantha Erraguntla Sponsorship Chair, VLSI 2011

Intel Technology India Pvt. Ltd. vasantha.erraguntla@intel.com







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Sponsorship Packages

Besides the individual sponsorships, there are sponsorship packages available for sponsors who want to derive exclusive benefits from the conference. The packages available are:

S. No.	Packages	Amount (Rs.)	# of Packages	# Available
1.	Silicon	700000	1	1
2.	Platinum	500000	3	3
3.	Gold	400000	4	4
4.	Silver	300000	6	6
5.	Bronze	200000	8	8

Note: Sponsorship attracts Service Tax @ 10.30%, in addition to the above rates. Service tax payment remittance to the government should be <u>made by the sponsor directly</u>, and not to VLSI 2011. And, please provide that acknowledgement to the conference at the earliest possible time.

Silicon Sponsorships: Silicon sponsors will get the following benefits:

- First right to select premium sponsorship items
- Name on the front cover of the conference program brochure/souvenir
- Banners on the side walls of the main hall of the conference.
- Appropriately sized name and logo on the side panels of the backdrop of the conference halls' stage
- Appropriately sized logo display in the conference website
- Coverage in print media
- Centre spread in the conference souvenir (sponsor to provide the ad within time line specified)
- 25% discount for exhibition booths
- 7 free invitation passes to the banquet session (if held)
- 7 free invitation passes to the cultural evening (if held)
- 12 free (registrations) invitations to 2 day tutorial or 3 day conference (sponsors are expected to communicate the choice by the early registration deadline)
- 15 free fellowship registrations

There will be one exclusive Silicon sponsor for the conference.

Platinum Sponsorships: Platinum sponsors (3 in number) will get the following benefits:

- Right to select premium sponsorship items (after Silicon)
- Appropriately sized name and logo on the side panels of the backdrop of the conference halls' stage
- Appropriately sized logo display in the conference website
- Coverage in print media







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- Inside cover ad in the conference souvenir (sponsor to provide the ad within time line specified)
- 25% discount for exhibition booths
- 5 free invitation passes to the banquet session (if held)
- 5 free invitation passes to the cultural evening (if held)
- 8 free (registrations) invitations to 2 day tutorial or 3 day conference (sponsors are expected to communicate the choice by the early registration deadline)
- 10 free fellowship registrations

Gold Sponsorships: Gold sponsors (4 in number) will get the following benefits:

- Right to select premium sponsorship items (after Silicon and Platinum sponsors)
- Appropriately sized name and logo on the side panels of the backdrop of the conference halls' stage
- Appropriately sized logo display in the conference website
- Coverage in print media
- Book mark in the souvenir (along with other Gold sponsors i.e. 3 logos on the bookmark)
- 25% discount for exhibition booths
- 4 free invitation passes to the banquet session (if held)
- 4 free invitation passes to the cultural evening (if held)
- 6 free (registrations) invitations to 2 day tutorial or 3 day conference (sponsors are expected to communicate the choice by the early registration deadline)
- 5 free fellowship registrations

Silver Sponsorships: Silver sponsors (6 in number) will get the following benefits:

- Right to select premium sponsorship items (after Silicon, Platinum and Gold sponsors)
- Appropriately sized name and logo on the side panels of the backdrop of the conference halls' stage
- Appropriately sized logo display in the conference website
- Coverage in print media
- One page color ad in the conference souvenir (sponsor to provide the ad within time line specified)
- 25% discount for exhibition booths
- 3 free invitation passes to the banquet session (if held)
- 3 free invitation passes to the cultural evening (if held)
- 3 free (registrations) invitations to 2 day tutorial or 3 day conference (sponsors are expected to communicate the choice by the early registration deadline)
- 3 free fellowship registrations

Bronze Sponsorships: Bronze sponsors (8 in number) will get the following benefits:

 Right to select premium sponsorship items (after Silicon, Platinum, Gold and Silver sponsors)







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- Appropriately sized name and logo on the side panels of the backdrop of the conference halls' stage
- Appropriately sized logo display in the conference website
- Coverage in print media
- Half a page color ad in the souvenir (sponsor to provide the ad within time line specified)
- 25% discount for exhibition booths
- 2 free invitation pass to the banquet session (if they are held)
- 2 free invitation pass to the cultural evening (if they are held)
- 2 free (registrations) invitations to 2 day tutorial or 3 day conference (sponsors are expected to communicate the choice by the early registration deadline)
- 2 free fellowship registrations

NOTE:

Keynotes at VLSI2011 will be part of the day time technical program – morning session and after lunch. For presenting a keynote at VLSI2011, please provide your topic and speaker details to the technical program chair. We request that keynotes be technical in nature and not a marketing/business related. **Selection is at the sole discretion of the conference committee.**

SPONSORS REPLY FORM (VLSI Design 2011)

1. Name and address of the sponsor:

Homepage Website URL:	
z. Homepage Website ONL.	
3. Name of the contact person:	
Tel:	Mobile:
Fax:	E-mail:
4. Declaration: We would like to sponsor the	e following conference event(s):
Package (circle one): Silicon, Platinum, Gold details)	d, Silver, Bronze, Sponsorship Items (pl. provide
Net Amount: Rs	
Enclosed please find a bank draft**/cheque	number: dated
drawn on	(bank)
** Demand Draft/at par Cheque should be di CHENNAI	Irawn on " VSI – VLSI DESIGN 2011 " payable at
Signature	Date:







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	3	-	0.50.000				
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	1	3	1,50,000				
ign-EDA-Systems Contest	ı	1	1,50,000				
orial	8	8	1,00,000				
dent Track	2	2	1,00,000				
ow Sponsorship (6 Fellows)	8	8	1,00,000				
stry Forum	1	1	30,000				
Sponsorship Items							
istration Bag	2	2	2,50,000				
ference Shirt	1	1	3,00,000				
ference T-Shirt	1	1	2,50,000				
	1	1	2,00,000				
ference Mug	1	1	1,75,000				
	2	2	1,00,000				
e Pad	2	2	50,000				
Banner / Board Advertising							
ners in Registration Area	3	3	1,00,000 (for Main Conference) 75,000 (for Tutorials) 50,000 (for Student Track)				
ners in Conference area	4	3	10,000 per banner				
ners in Exhibit area			5,000 per banner				
gram schedule boards	2	2	50,000				
Souvenir							
Normal Page color		3	30,000				
Page color			20,000				
Normal Page B/W		4	15,000				
Page B/W	4	4	10,000				







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Details of Sponsorship Items

- **1. Inaugural Ceremony** This will take place on the morning of January 4th, 2011. A leading government official or a prominent person from the industry chosen by the conference will inaugurate the ceremony. As a sponsor, a suitable dignitary from your company will introduce the speaker, and you will be the host for lunch on the Inaugural day (company's name will be prominently displayed on banners during lunch).
- **2. Banquet and Awards Dinner Night** There will be a banquet dinner on January 5th, 2011. A prominent industry figure will deliver the banquet speech. Sponsorship for this event will also ensure your company's name and banner be prominently displayed during this event. Your company's name will also be printed on the banquet invitation cards. It will also be mentioned as a sponsor in the conference brochure and program as well.
- **3. Special sessions and panels** These will involve stalwarts from the industry and academia presenting or discussing topics of relevance, as decided by the conference program committee. This time we have 2 workshops on "Reliable system design" and "Secure system design". Sponsorship for this event will ensure your company's name and banner be prominently displayed during this event. Your company's name will be mentioned as a sponsor in the conference brochure and program as well.
- **4. Design-EDA-Systems Contest** The aim of the contests is to promote excellence in design, EDA and systems in educational, research and industry establishments by providing a platform for professionals in the field of "VLSI and Embedded System" to showcase their designs and tools. The contest will be named after the sponsoring company.
- **5. Student Track** A one-day student track will be held for students from premier colleges on afternoon January 5th and January 6th 2011.
- **6. Tutorial Sponsorships** The conference will run 8 tutorials on topics of interest on the first two days of the conference. The tutorials are a high point of the conference. They are well attended by the industry and conference fellows. Each tutorial can be sponsored separately. As sponsors, your company name will be printed on the tutorial material given to each attendee. Your company's name and logo will be displayed prominently during the tutorial sessions. Banners with your company name will also be displayed during the lunch at the lunch area on the day of the tutorial. Your company's name will be mentioned as a sponsor in the conference brochure and program as well.
- **7. Registration Bag Sponsorship** Sponsors of the registration kit will have their name and logo prominently displayed on the registration bag. At least 2 sponsors are expected for the bag (to share the cost) and close to 600 bags are expected to be made that will be given to each conference delegate







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- **8. Conference Shirt/T-Shirt Sponsorship** Sponsors will have their name and logo prominently displayed on the conference Shirt/T-shirt that will be given to all conference registrants.
- **9. Conference Mug Sponsorship** Sponsor will have its name and logo prominently displayed on the conference mug that will be given to all conference registrants.
- **10.** Cap Sponsor will have its name printed on the cap that will be given away to registered delegates at the conference.
- **11. Fellowship Sponsorship** Academic Fellows are students who attend the conference on financial assistance provided by the Fellowship Sponsors. This sponsorship will allow worthy students to attend the conference at nominal cost. As a Fellowship sponsor, you would sponsor any number of fellows to the conference. The sponsored fellow's registration kit would include a badge displaying the name of the sponsoring company. Your company's name will be mentioned as a sponsor in the conference brochure and program. A special acknowledgement by Steering Committee will also be made for all the Fellowship sponsors.
- **12. Advertisements in Souvenir** Full-page color advertisements will be inserted in the souvenir. You will need to provide the four-color separations images of your ads.
- **13. Administrative Support** Following administrative support sponsorships are available: (This is not listed in the table)
 - Video streaming
 - UPS
 - Internet Access

As sponsors for these items, you would be required to supply the requisite support during the conference. Sponsorship of the above ensures a banner prominently displaying company's logo and name. Your company's name will be mentioned as a sponsor in the conference brochure and program as well.

NOTE:

- All the information and contents for the display material, boards and banners to be put up as part of sponsorship in various categories will have to be supplied by the sponsors
- For Exhibits, please refer to the "Exhibit Options" tab at the Conference website (http://www.vlsiconference.com)

Contact: Sponsorship Chair, Vasantha Erraguntla

Vasantha.erraguntla@intel.com